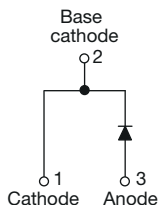


Fast Soft Recovery Rectifier Diode, 20 A



2L TO-220AC



FEATURES

- Glass passivated pellet chip junction
- AEC-Q101 qualified
- Meets JESD 201 class 1A whisker test
- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- On-board and off-board EV/HEV battery chargers
- Renewable energy inverters

DESCRIPTION

The VS-20ETF0... fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	20 A
V_R	600 V
V_F at I_F	1.3 V
I_{FSM}	300 A
t_{rr}	60 ns
T_J max.	150 °C
Snap factor	0.6
Package	2L TO-220AC
Circuit configuration	Single

MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
V_{RRM}	Range	600	V
$I_{F(AV)}$	Sinusoidal waveform	20	A
I_{FSM}		300	
t_{rr}	1 A, 100 A/μs	60	ns
V_F	10 A, $T_J = 25$ °C	1.2	V
T_J	Range	-40 to +150	°C

VOLTAGE RATINGS

PART NUMBER	V_{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM} AT 150 °C mA
VS-20ETF06THM3	600	700	5

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 97$ °C, 180° conduction half sine wave	20	A
Maximum peak one cycle non-repetitive surge current	I_{FSM}	10 ms sine pulse, rated V_{RRM} applied	250	
		10 ms sine pulse, no voltage reapplied	300	
Maximum I^2t for fusing	I^2t	10 ms sine pulse, rated V_{RRM} applied	316	A ² s
		10 ms sine pulse, no voltage reapplied	442	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1$ to 10 ms, no voltage reapplied	4420	A ² √s

**ELECTRICAL SPECIFICATIONS**

PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	V_{FM}	20 A, $T_J = 25\text{ }^{\circ}\text{C}$		1.3	V
Forward slope resistance	r_t	$T_J = 150\text{ }^{\circ}\text{C}$		12.5	m Ω
Threshold voltage	$V_{F(TO)}$			0.9	V
Maximum reverse leakage current	I_{RM}	$T_J = 25\text{ }^{\circ}\text{C}$	$V_R = \text{Rated } V_{RRM}$	0.1	mA
		$T_J = 150\text{ }^{\circ}\text{C}$		5.0	

RECOVERY CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Reverse recovery time	t_{rr}	I_F at 20 A _{pk} 100 A/ μ s 25 $^{\circ}\text{C}$	160	ns	
Reverse recovery current	I_{rr}		10	A	
Reverse recovery charge	Q_{rr}		1.25	μ C	
Snap factor	S	Typical	0.6		

THERMAL - MECHANICAL SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.9	°C/W
Maximum thermal resistance, junction to ambient	R _{thJA}		62	
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, and greased	0.5	
Approximate weight			2	g
			0.07	oz.
Mounting torque	minimum		6 (5)	kgf · cm (lbf · in)
	maximum		12 (10)	
Marking device		Case style 2L TO-220AC	20ETF06TH	

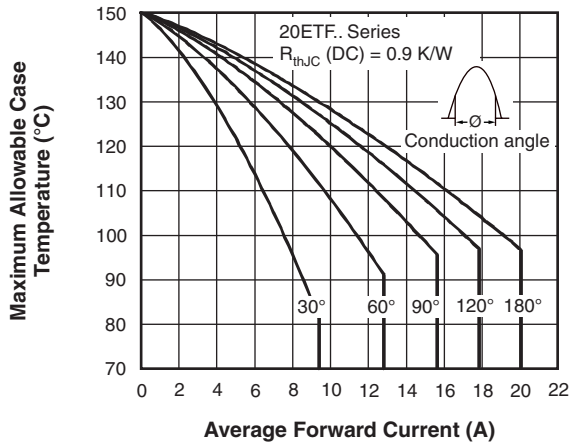


Fig. 1 - Current Rating Characteristics

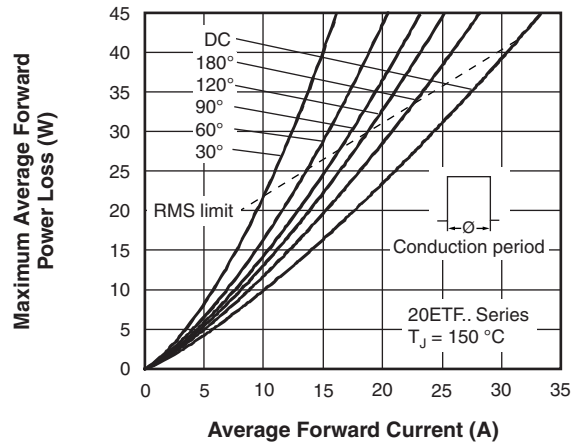


Fig. 4 - Forward Power Loss Characteristics

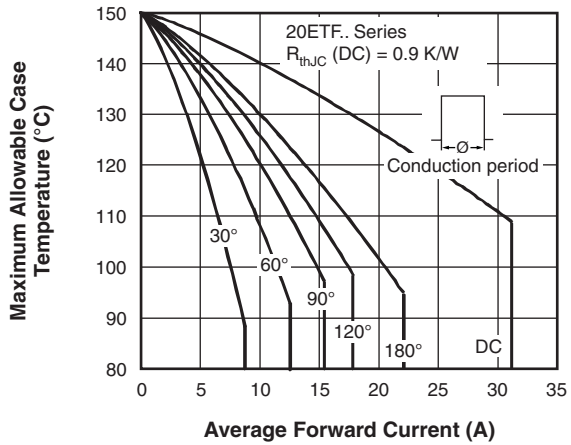


Fig. 2 - Current Rating Characteristics

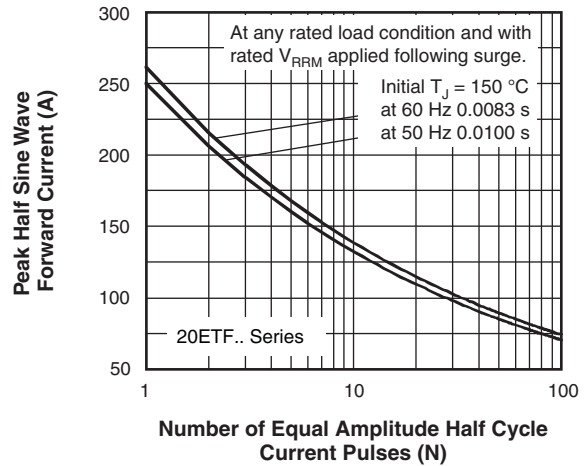


Fig. 5 - Maximum Non-Repetitive Surge Current

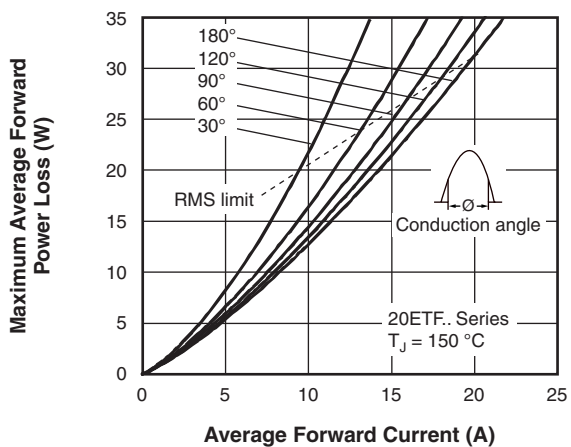


Fig. 3 - Forward Power Loss Characteristics

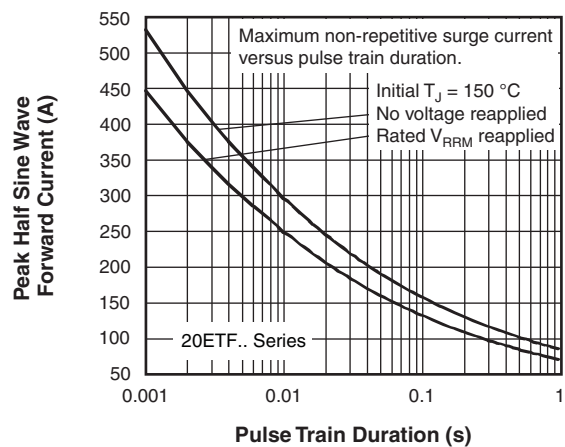


Fig. 6 - Maximum Non-Repetitive Surge Current

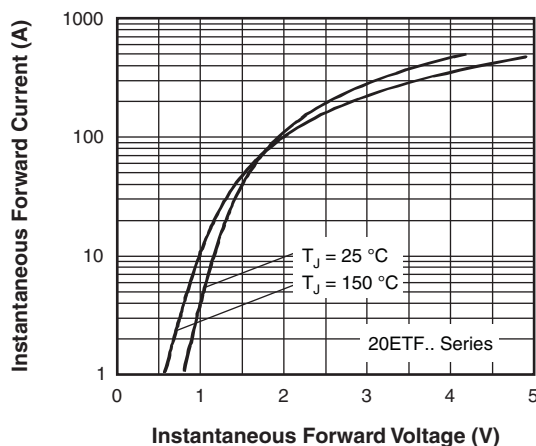
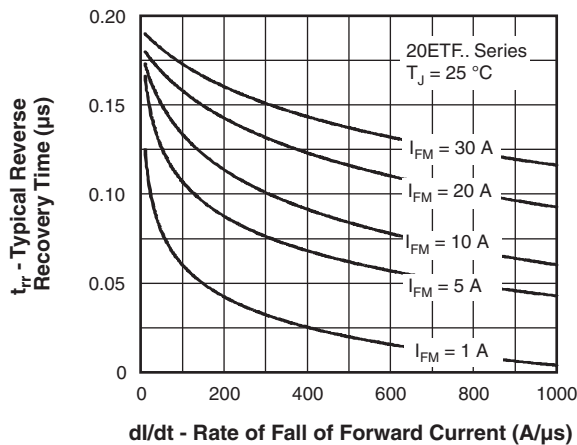
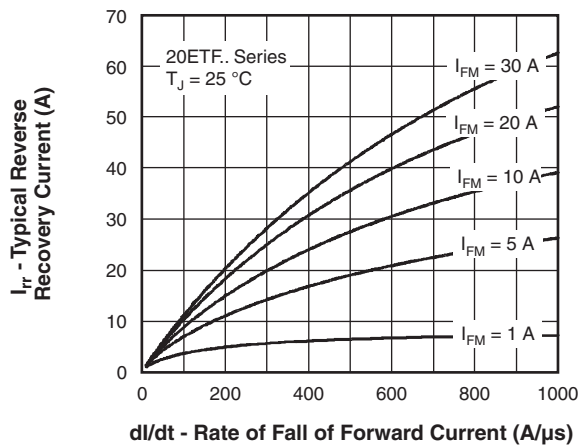
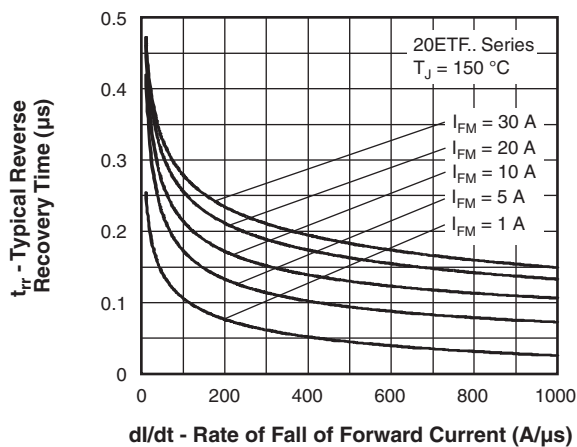
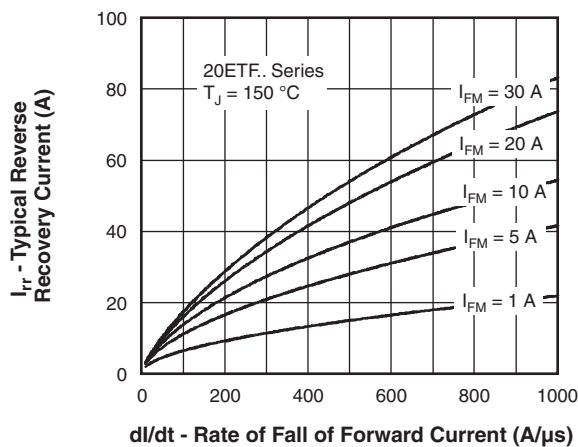
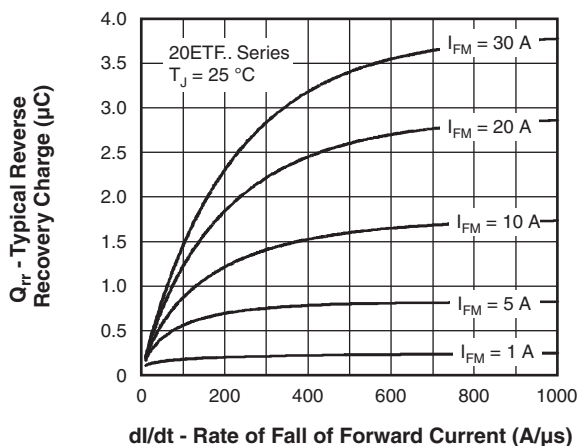
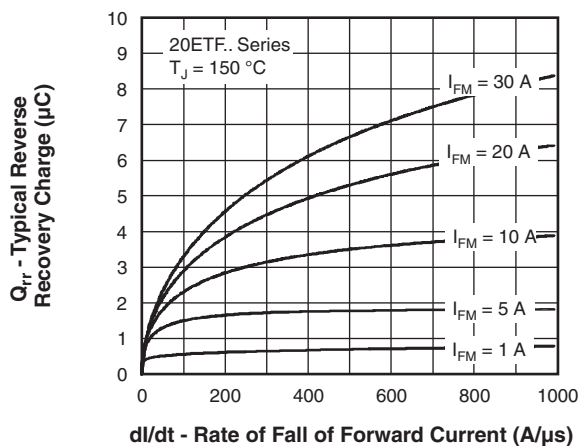
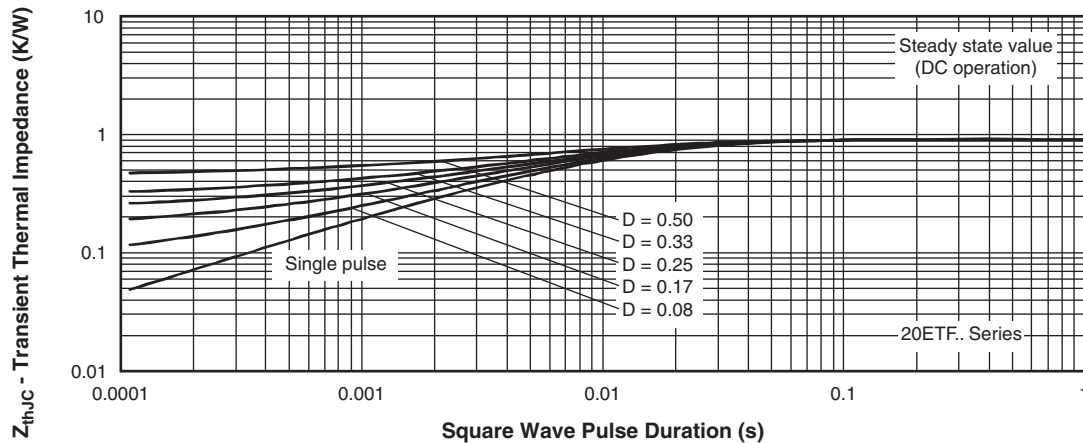


Fig. 7 - Forward Voltage Drop Characteristics


Fig. 8 - Recovery Time Characteristics, $T_J = 25\text{ }^{\circ}\text{C}$

Fig. 10 - Recovery Charge Characteristics, $T_J = 25\text{ }^{\circ}\text{C}$

Fig. 9 - Recovery Time Characteristics, $T_J = 150\text{ }^{\circ}\text{C}$

Fig. 11 - Recovery Charge Characteristics, $T_J = 150\text{ }^{\circ}\text{C}$


Fig. 12 - Recovery Current Characteristics, $T_J = 25^\circ\text{C}$

Fig. 13 - Recovery Current Characteristics, $T_J = 150^\circ\text{C}$

Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

**ORDERING INFORMATION TABLE**

Device code	VS-	20	E	T	F	06	T	H	M3
	1	2	3	4	5	6	7	8	9
1	- Vishay Semiconductors product								
2	- Current rating (20 = 20 A)								
3	- Circuit configuration: E = 2L TO-220AC A = 3L TO-220AB, common anode								
4	- Package: T = TO-220								
5	- Type of silicon: S = standard recovery rectifier								
6	- Voltage code x 100 = V_{RRM} ——— 06 = 600 V								
7	- • None = TO-220AB • T = True pin TO-220								
8	- H = AEC-Q101 qualified								
9	- Environmental digit: M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free								

ORDERING INFORMATION (Example)

PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-20ETF06THM3	50	1000	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS

Dimensions	www.vishay.com/doc?95259
Part marking information	www.vishay.com/doc?95391

True 2 Pin TO-220

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.32	4.57	0.170	0.180
b	0.71	0.91	0.028	0.036
b_1	1.15	1.39	0.045	0.055
c	0.36	0.53	0.014	0.021
D	14.99	15.49	0.590	0.610
E	10.04	10.41	0.395	0.410
e	5.08 BSC		0.200 BSC	
F	1.22	1.37	0.048	0.054
H_1	5.97	6.47	0.235	0.255
J_1	2.54	2.79	0.100	0.110
L	13.47	13.97	0.530	0.550
$L_1^{(1)}$	3.31	3.81	0.130	0.150
$\varnothing P$	3.79	3.88	0.149	0.153
Q	2.60	2.84	0.102	0.112

Notes

⁽¹⁾ Lead dimension and finish uncontrolled in L_1

- These dimensions are within allowable dimensions of JEDEC TO-220AB rev. J outline dated 3-24-87
- Controlling dimension: Inch



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